



Material Content Data Sheet



Sales Product Name		SMBTA 06 E6327		Issued		28. August 2013		
MA#		MA000050140						
Package		PG-SOT23-3-4		Weight*		9.08 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000	0.00		14	
	noble metal	gold	7440-57-5	0.013	0.14		1415	
	inorganic material	silicon	7440-21-3	0.110	1.21	1.35	12086	13515
leadframe	non noble metal	chromium	7440-47-3	0.009	0.10		996	
	inorganic material	silicon	7440-21-3	0.001	0.01		66	
	non noble metal	titanium	7440-32-6	0.003	0.03		332	
	non noble metal	copper	7440-50-8	3.001	33.05	33.19	330493	331887
wire	noble metal	gold	7440-57-5	0.018	0.20	0.20	2013	2013
	encapsulation	organic material	carbon black	0.091	1.00		10008	
	inorganic material	antimonytrioxide	1309-64-4	0.136	1.50		15011	
	plastics	brominated resin	-	0.170	1.88		18764	
	plastics	epoxy resin	-	1.420	15.64		156369	
	inorganic material	silicondioxide	60676-86-0	3.862	42.53	62.55	425326	625478
leadfinish	non noble metal	tin	7440-31-5	0.136	1.50	1.50	15025	15025
plating	noble metal	silver	7440-22-4	0.110	1.21	1.21	12082	12082
*deviation	< 10%		Sum in total:			100,00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
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3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

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